

SPICE Device Model Si1553DL

Vishay Siliconix

Complementary 2.5-V (G-S) MOSFET

CHARACTERISTICS

- N- and P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

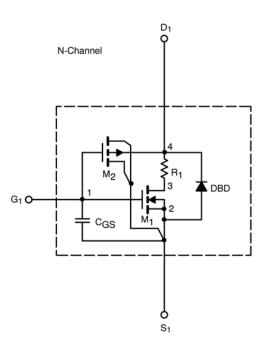
- · Apply for both Linear and Switching Application
- Accurate over the –55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

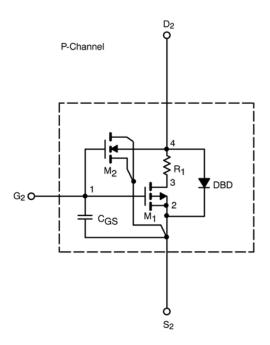
DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n- and p-channel vertical DMOS. The subcircuit model is extracted and optimized over the $-55\ to\ 125^{\circ}C$ temperature ranges under the pulsed 0-V to 5-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched $C_{\rm gd}$ model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC





This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

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SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition		Simulated Data	Measured Data	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	N-Ch	1		V
		$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	P-Ch	1.1		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \geq 5 \text{ V}, V_{GS}$ = 4.5 V	N-Ch	7		А
		$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	3.1		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 4.5 V, I_{D} = 0.66 A	N-Ch	0.33	0.32	Ω
		V_{GS} = -4.5 V, I_{D} = -0.41 A	P-Ch	0.85	0.85	
		$V_{GS} = 2.5 \text{ V}, I_D = 0.40 \text{ A}$	N-Ch	0.53	0.56	
		$V_{GS} = -2.5 \text{ V}, I_D = -0.25 \text{ A}$	P-Ch	1.33	1.4	
Forward Transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 0.66 A	N-Ch	1.5	1.5	S
		V _{DS} = -10 V, I _D = -0.41 A	P-Ch	0.8	0.8	
Diode Forward Voltage ^a	V_{SD}	$I_{\rm S}$ = 0.23 A, $V_{\rm GS}$ = 0 V	N-Ch	0.75	0.80	V
		$I_S = -0.23 \text{ A}, V_{GS} = 0 \text{ V}$	P-Ch	-0.76	-0.80	
Dynamic ^b			•			
Total Gate Charge	Q_g		N-Ch	0.65	0.80	nC
		N-Channel $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 0.66 \text{ A}$ P-Channel $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -0.41 \text{ A}$	P-Ch	0.54	1.2	
Gate-Source Charge	Q_gs		N-Ch	0.06	0.06	
			P-Ch	0.15	0.45	
Gate-Drain Charge	Q_{gd}		N-Ch	0.30	0.30	
			P-Ch	0.075	0.25	
Turn-On Delay Time	$t_{d(on)}$	N-Channel V_{DD} =10 V, R_L = 20 Ω $I_D \cong 0.50$ A, V_{GEN} = 4.5 V, R_G = 6 Ω	N-Ch	9.4	10	ns
			P-Ch	8.8	7.5	
Rise Time	t _r		N-Ch	12	16	
			P-Ch	11	20	
Turn-Off Delay Time	t _{d(off)}	P-Channel	N-Ch	16	10	
		$V_{DD} = -10 \text{ V}, R_L = 20 \Omega$ $I_D \cong -0.50 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_G = 6 \Omega$	P-Ch	11	8.5	
Fall Time	t _f		N-Ch	17	10	
			P-Ch	12	12	
Source-Drain Reverse Recovery Time	t _{rr}	$I_S = 0.23 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	N-Ch	25	20	
		$I_S = -0.23 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	P-Ch	25	25	

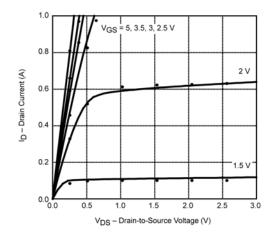
a. Guaranteed by design, not subject to production testing. b. b. Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.

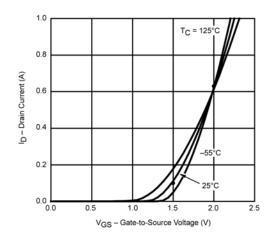


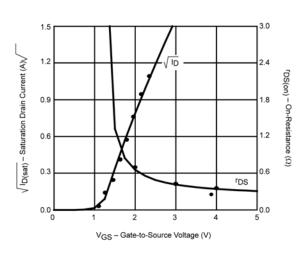
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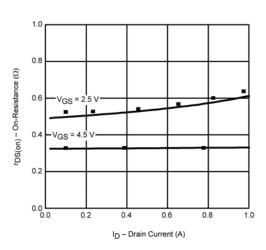
COMPARISON OF MODEL WITH MEASURED DATA (TJ=25°C UNLESS OTHERWISE NOTED)

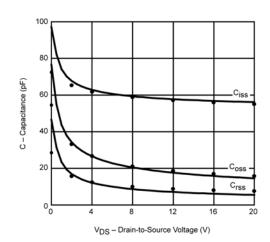
N-Channel MOSFET

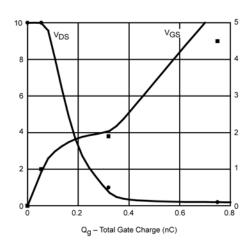












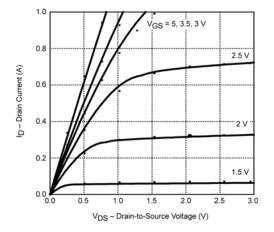
Note: Dots and squares represent measured data.

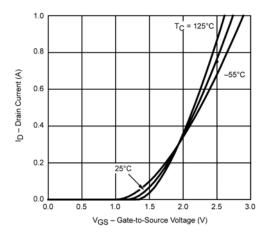
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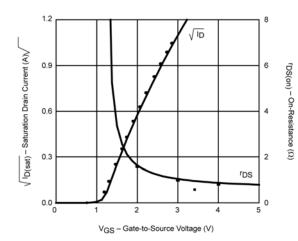
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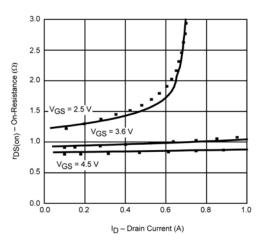
P-Channel MOSFET

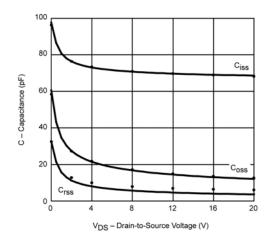


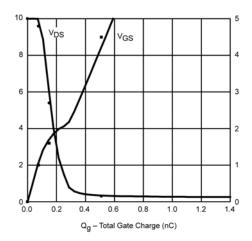












Note: Dots and squares represent measured data.



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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com